XP131A1520SR

Power MOSFET

■GENERAL DESCRIPTION

The XP131A1520SR is an N-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy. The small SOP-8 package makes high density mounting possible.

■ APPLICATIONS

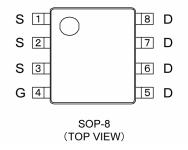
Notebook PCs

- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

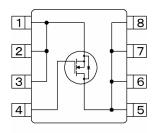


Low On-State Resistance	: Rds(on)=0.015(Vgs=10V)
	: Rds(on)=0.02 Ω (Vgs=4.5V)
Ultra High-Speed Switchir	ng
Driving Voltage	: 4.5V
N-Channel Power MOSFE	Т
DMOS Structure	
Package	: SOP-8

■ PIN CONFIGURATION



■EQUIVALENT CIRCUIT



N-channel MOSFET (1 device built-in)

■PIN ASSIGNMENT

PIN NUMBER	PIN NAME	FUNCTION
1~3	S	Source
4	G	Gate
5~8	D	Drain

■ABSOLUTE MAXIMUM RATINGS

Ta =	25°C
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PARAMETER	SYMBOL	RATINGS	UNITS
Drain-Source Voltage	Vdss	30	V
Gate-Source Voltage	Vgss	±20	V
Drain Current (DC)	ld	10	А
Drain Current (Pulse)	ldp	40	А
Reverse Drain Current	ldr	10	А
Channel Power Dissipation *	Pd	2.5	W
Channel Temperature	Tch	150	°C
Storage Temperature Range	Tstg	-55~150	°C

* When implemented on a glass epoxy PCB

■ELECTRICAL CHARACTERISTICS

DC Characteristics

DC Characteristics					Т	a = 25°C
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds=30V, Vgs=0V	-	-	10	μA
Gate-Source Leak Current	lgss	Vgs=±20V, Vds=0V	-	-	±1	μA
Gate-Source Cut-Off Voltage	Vgs(off)	ld=1mA, Vds=10V	1.0	-	2.5	V
Drain-Source On-State Resistance *	Rds(on)	ld=5A, Vgs=10V	-	0.012	0.015	Ω
		ld=5A, Vgs=4.5V	-	0.016	0.020	Ω
Forward Transfer Admittance *	Yfs	ld=5A, Vds=10V	-	20	-	S
Body Drain Diode Forward Voltage	Vf	lf=10A, Vgs=0V	-	0.8	1.1	V

* Effective during pulse test.

Dynamic Characteristics

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PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds=10V, Vgs=0V f=1MHz	-	1370	-	pF
Output Capacitance	Coss		-	740	-	pF
Feedback Capacitance	Crss		-	280	-	pF

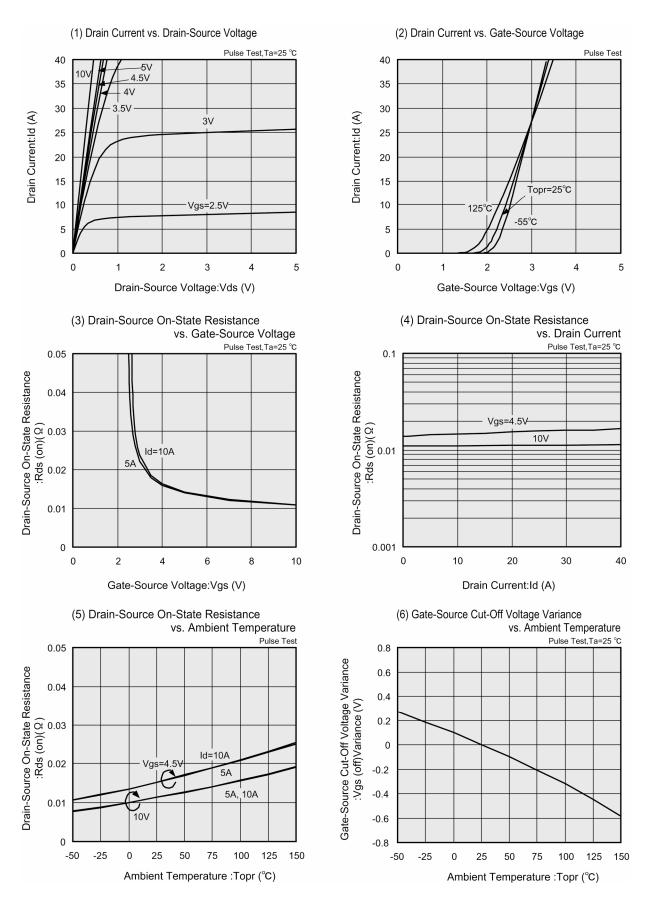
Switching Characteristics

Switching CharacteristicsTa = 25°C						
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs=5V, Id=5A Vdd=10V	-	20	-	ns
Rise Time	tr		-	25	-	ns
Turn-Off Delay Time	td (off)		-	40	-	ns
Fall Time	tf		-	20	-	ns

Thermal Characteristics

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a glass epoxy resin PCB	-	50	-	°C/W

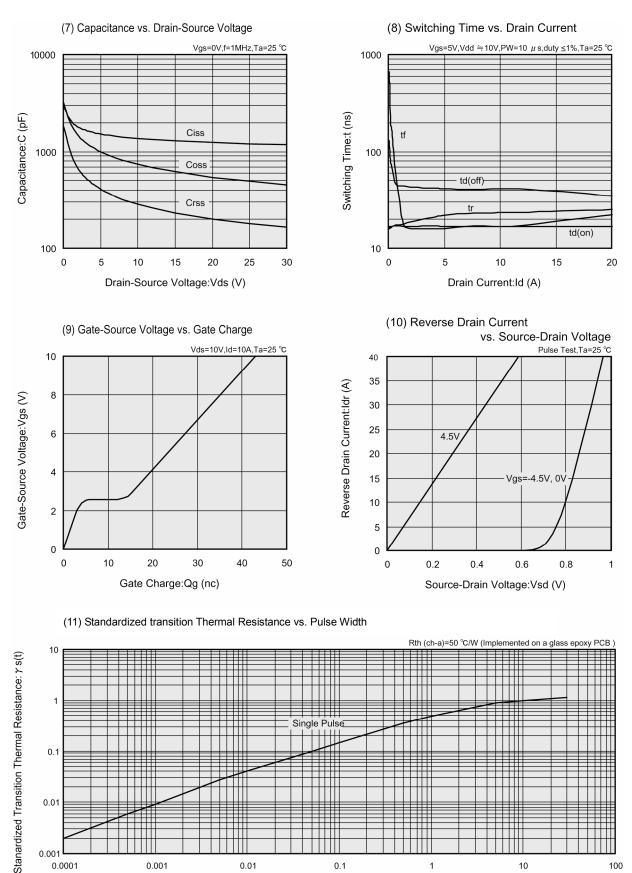
Ta = 25°C



TYPICAL PERFORMANCE CHARACTERISTICS

TOIREX 3/5

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



1

10

100

0.001

0.0001

0.001

0.01

0.1

Pulse Width: PW (s)

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